



Page 1 of 15

DIODES, POWER RECTIFIER, SCHOTTKY BARRIER

BASED ON TYPE STP030100

ESCC Detail Specification No. 0106/018

Issue 1

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Administrative/General Notes

(Refer to specifications for ESCC 0000 series)

Item No.	General Description
101	Administrative/General Notes/Specified ESCC



TABLE OF CONTENTS

1.	<u>GENERAL</u>	1.
1.1	Scope	1
1.2	Applicable Documents	1
1.3	Terms / Definitions, Abbreviations, Symbols and Units	1
1.4	The ESCC Component Number and Component Type Variants	1
1.4.1	The ESCC Component Number	1
1.4.2	Component Type Variants	1
1.5	Maximum Ratings	1
1.6	Handling/Precautions	2
1.7	Physical Dimensions and Terminal Identification	2
1.7.1	Mount Flange Mount Package (TO-18) - 8 Lead	2
1.7.2	Surface Mount Package (SMD) - 8 Terminal	1
1.7.3	Surface Mount Package (SMD) - 4 Terminal	1
1.7.4	Notes to Physical Dimensions and Terminal Identification	1
1.8	Functional Diagram	11
1.9	Materials and Finishes	11
2.	<u>REQUIREMENTS</u>	2.
2.1	General	11
2.1.1	Exclusions from the General Specification	11
2.1.1.1	Exclusions from Screening Tests - Clean Pk	11
2.1.1.2	Exclusions from Qualification and Periodic Tests - Clean Pk	11
2.2	Marking	11
2.3	Terminal Strength	12
2.4	Electrical Measurements at Room, High and Low Temperatures	12
2.4.1	Room Temperature Electrical Measurements	12
2.4.2	High and Low Temperature Electrical Measurements	12
2.4.3	Notes to Electrical Measurement Tables	12
2.5	Parameter Drift/Values	12
2.6	Intermittent and Sustained Electrical Measurements	12
2.7	Power/Current Conditions	12
2.8	Operating Life Conditions	12
APPENDIX A)		12



5. GENERAL

5.1 SCOPE

This specification details the ratings, physical and chemical characteristics and test and inspection data for the component type variants within the range of components specified below. It supplements the requirements of associated test result in conjunction with the ESCC General Specification (not under duplicate documents).

5.2 APPLICABLE DOCUMENTS

The following documents form part of the specification and shall be read in conjunction with it:

- a) ESCC General Specification No. 0000
- b) MIL-STD-130, Test Methods and Procedures for Semiconductor Devices

5.3 SYMBOLS, ABBREVIATIONS, DIMENSIONS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC General Specification No. 010000 shall apply.

5.4 THE ESCC COMPONENT NUMBERING AND COMPONENT IDENTIFICATION

5.4.1 The ESCC Component Number

The ESCC Component Number shall be constructed as follows:

Example: 0100101

- e – Seal Specification Reference (010010)
- e – Component Type Variant Number (01 – uncoated)

5.4.2 Component Test Values

The component type variants applications this specification are as follows:

Variant Number	Material Type	Case	Description	Lead Finish and Plating	Weight (max g)
01	01PCL0101	TO-18A	Single diode	100	10
02	01PCL0102	TO-18A	Diode array, common anode	100	10
03	01PCL0103	TO-18A	Diode array, common cathode	100	10
04	01PCL0104	TO-18A	Diode array, series common support	100	10



Variant Number	Based on Type	Case	Description	Lead Time (minimum order)	Weight (kg)
01	Standard	020019	Single-Block	12W	1
02	Standard	020019	Single-Block	12W	1
03	Standard	020019	Case Study, various options	12W	1

The manufacturer reserves the right to alter the seal specification with the agreement of other Seal Specification No. 020019.

6.2

6.2.1 Maximum Ratings

The maximum ratings shall not be exceeded at any time during use or storage.

Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC General Specification.

Characteristic	Symbol	Maximum Rating	Unit	Remarks
Forward Voltage (per Device)	V_{fmax}	200	V	None 1
Reverse Peak Voltage (per Device)	V_{rmax}	100	V	None 1
Reverse Peak Reverse Current	I_{rmax}	1	A	None 1
Average Output Rectifier Current (per Device)	I_{o}		A	None, may vary between 1, 2
di/dt (per Device)		100		
di/dt (di/dt) (per Device)		100		
ESD Tolerance (Per Device)	V_{ESDmax}	100	V	
Operating Temperature Range (Case Temperature)	T_c	-55 to +125	°C	None 1
Storage Temperature	T_s	-75 to +175	°C	
Storage Temperature Range	T_{stg}	-55 to +125	°C	None 1
Moisture Temperature (For TO-264)	T_{mo}	+200	°C	None 1
Moisture Temperature (For Standard)		+200	°C	None 1
Control Wave and/or Reverse Voltage	V_{cr}	10000	V/µs	
Thermal Resistance, Junction to Case (per Device)	θ_{j-c}	100	°C/W	None 1, 2
Thermal Resistance, Junction to Ambient (per Device)		100	°C/W	
Thermal Resistance, Junction to Board (per Device)		100	°C/W	
Thermal Resistance, Junction to Ambient (per Device)		100	°C/W	

**NOTES**

1. Minimum gage of 10mm diameter.
2. Polished, standard fine, ± 0.0125 .
3. Polished, standard fine, ± 0.125 .
4. For $T_{max} = 1.0 \times 10^3$ °C, tested frequency 50 at ± 0.01 °C.
5. For $T_{max} = 1.0 \times 10^3$ °C, tested frequency 50 at ± 0.01 °C, and the contact with a 10% inert atmosphere.
6. Sealer to extend maximum area diameter of not less than 1.5mm from the device body and the same level shall not be considered until 5 minutes have elapsed.
7. Sealer to extend maximum area diameter shall not be considered until 5 minutes have elapsed.
8. Package mounted on individual terminals.
9. The joint related ratings apply only as follows:
 *Voltage: 50V when both contacts terminals are disconnected.
 *Voltage: 50V and 50V when both contact terminals are fast together.

6.6. NON-FLUOROCARBON

The TIGER package contains Beryllium Oxide (BeO) and therefore it must not be ground, machined, sandblasted or subjected to any other mechanical operations which will produce heat. The user must not be subjected to any chemical process (e.g. etching) which will produce fumes.

6.7. SEALING, IDENTIFICATION AND MINIMUM DIMENSIONS

Component sizes are given following the case drawings and dimensions.

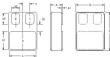
6.24. Lead Length (When Sealing) (ESCC) (4mm)

Symbols	Dimension (mm)		Notes
	Min	Max	
a	10.00	1.50	
b	10.00	1.50	



Symbol	Dimensions mm		Notes
	Min	Max	
L	20.27	20.52	
D	6.3	6.7	
E	1	1.03	
W	6.5	6.8	
G	10.20	11.0	
H	0.0050		
W1	6.50	1.00	2
J	0.0750		
K	0.0750		
L	12.00	1.00	
W2	0.00750		2
M	-	0.01	2
N1	-	1	2
N2	1.00750		2

6.2.2

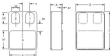
Endorsement Symbols (ESCC – Issuing)

Symbol	Dimensions mm		Notes
	Min	Max	
L	20.0	21.0	
L1	12.0	13.0	
H	2.00	2.00	
N1	6.50	6.50	
N2	6.50	6.50	1



Symbol	Dimensions mm		Notes
	Min	Max	
h1	200	215	1
h2	10.00	10.20	
h3	10.70	-	1
h4	1.00	0.80	
h5	1.20 ESCC		1

4.24 Radial Valve System (RVS) - Terminal



Symbol	Dimensions mm		Notes
	Min	Max	
h1	0.3	0.50	
h2	10.20	0.50	
h3	0.3	0.50	
h4	10.00	10.50	
h5	0.50	0.50	1
h6	0.50	0.70	1
h7	10.20	10	
h8	10.20	-	1
h9	1.1	11.00	
h10	2.00 ESCC		1

4.24 Notes on Physical Dimensions and Terminal Identification

- The terminal identification is specified by the component's geometry. See Fractional Diagram for the terminal connections.
- Ignored.
- Radial offset/differential range corner, optional.



- a. Seal is affixed across all pieces.
- b. 2 pieces.

4.2 FUNCTIONAL SYMBOLS

Terminal 1 (outside) Terminal 2 (interconnect) Terminal 3 (inside)	
Terminal 1 (outside) Terminal 2 (outside/inside) Terminal 3 (outside)	
Terminal 1 (inside) Terminal 2 (outside/inside) Terminal 3 (inside)	
Terminal 1 (inside) Terminal 2 (inside/stop) Terminal 3 (inside)	
Terminal 1 (inside/stop) Terminal 2 (outside)	
Terminal 1 (inside) Terminal 2 (inside) Terminal 3 (outside/inside)	

NOTES

- 1. For TD-420, the seal is not connected to any lead.
- 2. For 8003 and 8004, the seal is not connected to any terminal.



2.0 GENERAL USE AND FINISHES

Materials and finishes shall be as follows:

- a) Case
For the metal forged mount packages the case shall be thermally oxidized and have a metal body. The leads pass through ceramic sleeves bonded into the frame, and the lead shall be sealed.
For the surface mount packages the case shall be thermally oxidized and have a ceramic body with a Kovar lid.
- b) Leads/Terminals
As specified in Component Type Variants.

2. PERFORMANCE

2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the ESCC Generic Specification. Permitted deviations from the Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the Generic Specification and this Basic Specification, formally agreed with specific manufacturers, on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

2.1.1 Deviations from the Generic Specification

2.1.1.1 Deviation from Forwarding Terms - Class F10

- a) High Temperature Reverse Bias Burn-in and the subsequent Final Measurements for MTHB shall be omitted.

2.1.1.2 Deviation from Qualification and Periodic Tests - Class F10

- a) Constant Acceleration is not applicable.
- b) For ESCC Lead ESCR, Terminal Strength is not applicable.

2.2 MARKING

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 0100104 and as follows:

The information to be marked on the component shall be:

- a) Thru-hole qualified components: symbol for ESCC qualified components only.
- b) Thru-hole Component Number.
- c) Traceability information.
- d) Marking sign for RoHS-compliance (Pb-free only).

**2.0.1 General Information**

The test conditions for Terminal Strength, tested as specified in the ESCC General Specifications, shall be as follows:

For TD-8As, Test Condition 4, applies, with an applied force of 100N and a duration of 10s.

2.0.2 ELECTRICAL CHARACTERISTICS AT NORMAL OPERATING TEMPERATURES

Electrical measurements shall be performed at room, high and low temperatures. Correction factors are given after the values.

2.0.3 Room Temperature Electrical Measurements

The measurements shall be performed at $T_{amb} \pm 0.5^{\circ}\text{C}$.

Characteristic	Symbol	Reference Test Method	Test conditions Notes 1	Units		Units
				Min.	Max.	
Reverse Current	I_R	ESCC	DC Voltage $V_R = 100\text{V}$	-	mA	µA
Forward Voltage	V_{DF}	ESCC	DC Voltage $I_F = 10\text{mA}$ Notes 2	-	VDC	VDC
	V_{DF}	ESCC	DC Voltage $I_F = 10\text{mA}$ Notes 2	-	V	V
Capacitance	C_j	ESCC	$V_R = 100\text{V}$ $I_F = 10\text{mA}$	-	pF	pF
Forward Impedance, adjusted to 100MHz	$Z_{DF}(100)$	ESCC	$V_R = 10\text{V}$ ac rms, $I_F = 10\text{mA}$ $V_R = 10\text{V}$ ac rms, $I_F = 10\text{mA}$ Notes 2	(Calculate at f_c , see Note 2)		Ω

2.0.4 High and Low Temperature Electrical Measurements

Characteristic	Symbol	Reference Test Method	Test conditions Notes 1 and 2	Units		Units
				Min.	Max.	
Reverse Current	I_R	ESCC	$T_{amb} \pm 0.5^{\circ}\text{C}$ and 0°C DC Voltage $V_R = 100\text{V}$	-	mA	µA
Forward Voltage	V_{DF}	ESCC	$T_{amb} \pm 0.5^{\circ}\text{C}$ and 0°C DC Voltage $I_F = 10\text{mA}$ Notes 2	-	VDC	VDC
	V_{DF}	ESCC	$T_{amb} \pm 0.5^{\circ}\text{C}$ and 0°C DC Voltage $I_F = 10\text{mA}$ Notes 2	-	V	V

**2.4.2 Form of Electrical Measurement Tables**

1. Measurement per each slide.
2. Pulse width stability / Duty Cycle 10%.
3. Performance only during (or during Tests for similar test values (initial/Measurement)) gateways.
4. The test (or test) shall be defined by the Manufacturer company (or its successor) with min. 10% (or relevant or 10) accuracy guarantee the $V_{CE(sat)}$ limits specified in Maximum Ratings.
5. Read and record measurements: shall be performance a sample of 10 components with 3 values allowed. Alternatively a 100% inspection may be performed.

2.4.3 PERMISSIONS (NOT TESTS)

Unless otherwise specified, the measurements shall be performed at $T_{amb} = 25 \pm 0.5^\circ C$.

The test methods and test conditions shall be as per the corresponding test defined in IEC60747-15:2006 Temperature Electrical Measurements.

The tolerances (%) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Characteristics	Symbol	Limits		Units	
		Limit Value (*)	Direction		
			Min		Max
Reverse Current	I_{R0}	100 µA (typ) max	-	100	µA
Forward Voltage 1	V_{CE1}	1.0V	-	1.0V	V

NOTES

1. Whichever is the greater related to the limit value.

2.4.4 PERMISSIONS (ELECTRICAL POINT ELECTRICAL CHARACTERISTICS)

Unless otherwise specified, the measurements shall be performed at $T_{amb} = 25 \pm 0.5^\circ C$.

The test methods and test conditions shall be as per the corresponding test defined in IEC60747-15:2006 Temperature Electrical Measurements.

The tolerances for each characteristic shall not be exceeded.

Characteristics	Symbol	Limits		Units
		Min	Max	
Reverse current	I_{R0}	-	100	µA
Forward Voltage 1	V_{CE1}	-	1.0V	V



2.7 POWER SUPPLY CONDITIONS

Characteristic	Symbol	Test Conditions	Units
Case Temperature	T_{case}	25°C	°C
Receiver Voltage	V_{in}	5V	V

2.8 Additional test conditions

The conditions set as specified for Power Supply.



APPENDIX

QUALITY CONTROL AND TESTING PROCEDURES

ITEM SPECIFIED	DESCRIPTION OF PROCEDURE
Seedling Test Procedure - General. Ques 10	General QC Procedure - Seedling Test - general. Seedlings equal to 1.0 cm diameter was acceptable for handling with a 0.5 mm sieve.
Seedling Test Sowing Test. Ques 10	Seedling's emergence under sowing: Agreement to test - General Notes.